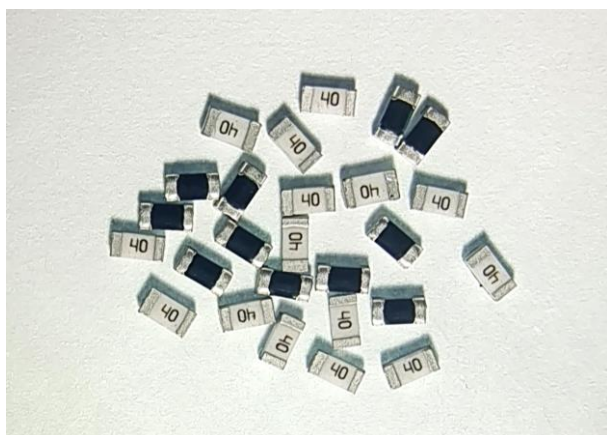




## General

- High Current
- 3.1mm× 1.6mm physical size
- Thick film manufacturing method, ceramic substrate, silver fusing element
- -55℃~155℃ operating temperature
- Excellent environmental integrity
- RoHS compliant
- Halogen-free
- Lead free

## Agency / Certificate Information

| Agency                                                                           | File Number | Ampere Range |
|----------------------------------------------------------------------------------|-------------|--------------|
|  | E319512     | 40A/45A      |

## Application

- Battery Systems
- Routers
- PC
- Garden tools/Electric tools
- Unmanned aerial vehicle (UAV)
- Power supplies
- Machinery and equipment
- Portable Energy Storage

## Electrical Specifications

| Part Number    | Marking | Current Rating (A) | Voltage Rating (V) | Interrupting Rating (V)    | Typical Cold DCR (mΩ) | Typical I <sup>2</sup> T** (A <sup>2</sup> sec) |
|----------------|---------|--------------------|--------------------|----------------------------|-----------------------|-------------------------------------------------|
| S1206-FG-40.0A | 40      | 40.0               | 35                 | 200A 35V DC<br>400A 26V DC | 0.8                   | 172.8                                           |
| S1206-FG-45.0A | 45      | 45.0               | 35                 |                            | 0.75                  | 223.9                                           |

\* Measured at ≤10% rated current and 25℃

\*\* Melting I<sup>2</sup>T at 10 times of rated current

## Part Number Information

S    1206—FG—40.0A

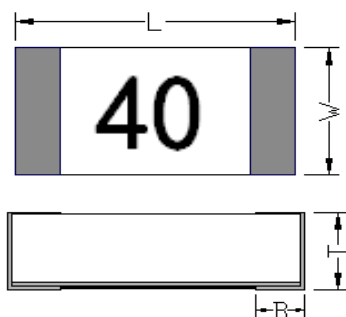
“40.0A” Ampere Rating: 40A

“FG” Electrical Characteristic: FG= High Current

“1206” Size Number

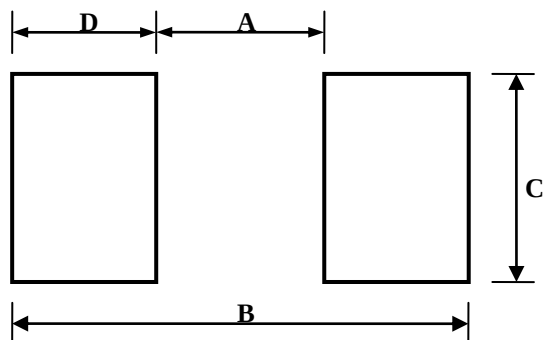
“S” Symbol of SART

## Dimensions



| Type     | L<br>(mm) | W<br>(mm) | T<br>(mm) | B<br>(mm) |
|----------|-----------|-----------|-----------|-----------|
| S1206-FG | 3.10±0.20 | 1.60±0.20 | 0.80±0.20 | 0.60±0.20 |

## Recommended Land Patterns



## Materials

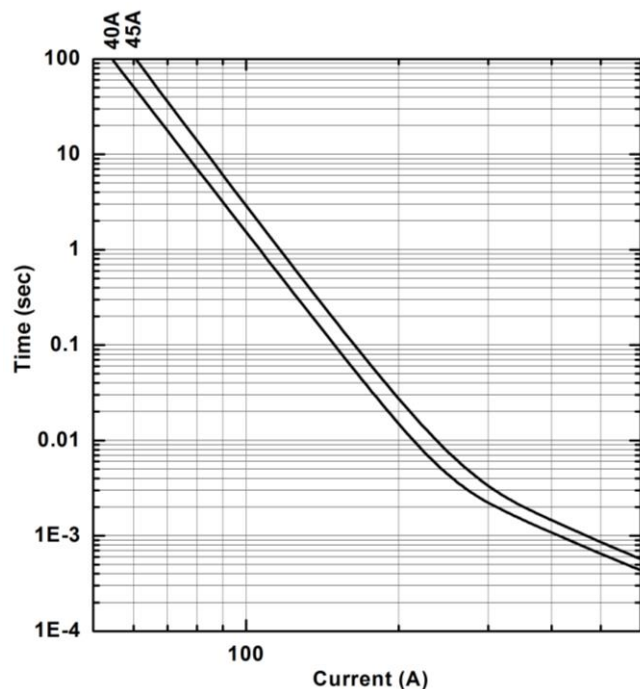
| Components   | Material                           |
|--------------|------------------------------------|
| Body         | Ceramic                            |
| Terminations | Silver over plated with tin (100%) |
| Element      | Silver or Silver/Palladium         |

| Type     | A(mm)     | B(mm)     | C(mm)     | D(mm)     |
|----------|-----------|-----------|-----------|-----------|
| S1206-FG | 1.60±0.10 | 3.80±0.10 | 2.20±0.10 | 1.10±0.10 |

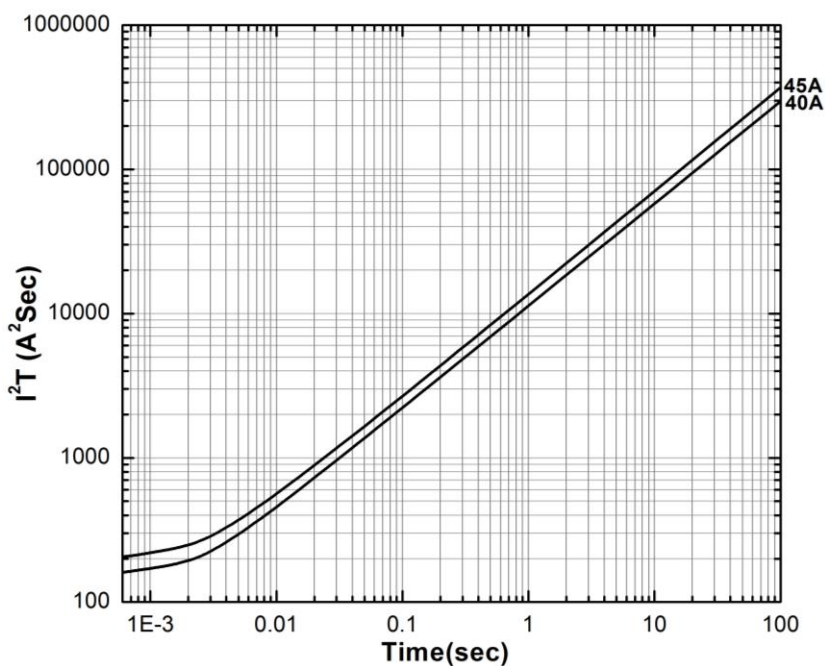
## Dimensions of Standard Test Board

| Type     | Ampere Rating | Board Thickness<br>(mm) | Copper Layer Thickness<br>(mm) | Copper Trace Width<br>(mm) |
|----------|---------------|-------------------------|--------------------------------|----------------------------|
| S1206-FG | 40.0A         | 1.6                     | 0.175                          | 10.0                       |
|          | 45.0A         | 1.6                     | 0.175                          | 15.0                       |

### Time Current Curve



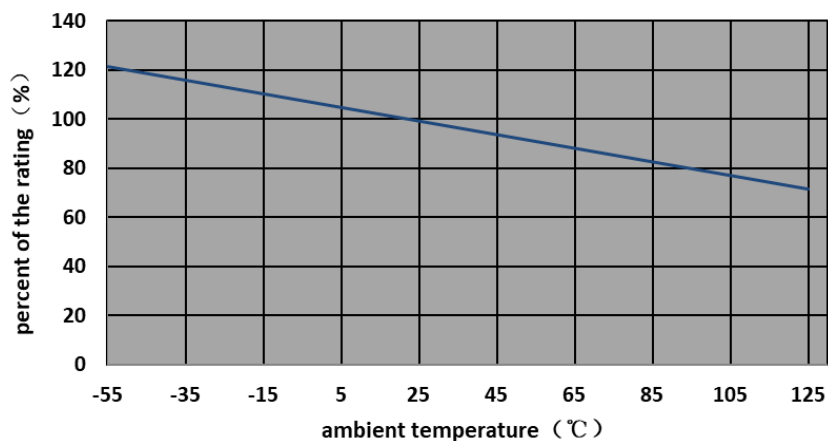
### $I^2T$ VS Time Curve



### Electrical Characteristics

| Type     | Ampere Rating | % of Current Rating | Opening Time |
|----------|---------------|---------------------|--------------|
| S1206-FG | 40.0A~45.0A   | 100                 | 4hours Min.  |
|          |               | 350                 | 5sec Max.    |
|          |               | 1000                | 0.5msec Min. |

### Temperature Derating Curve



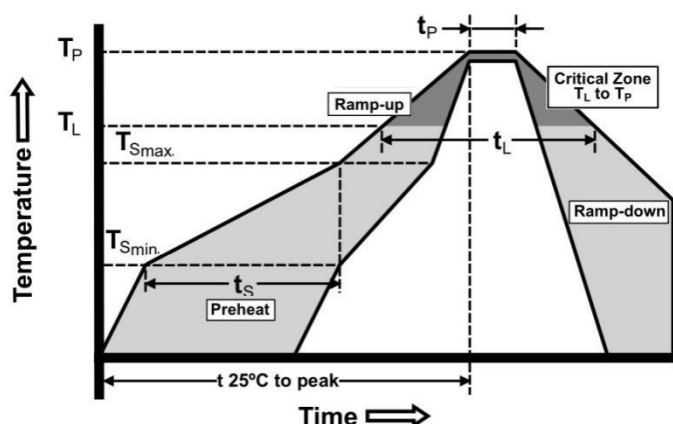
## Product Characteristics

| Item                            | Test condition/ Methods                                                                                                                        | Performance                                                  | Standard                                |
|---------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------|-----------------------------------------|
| Time/Current                    | 100% of current rating                                                                                                                         | No Fusing, 4hours Min.                                       | UL248-14                                |
|                                 | 350% of current rating                                                                                                                         | <5sec                                                        | SART SPEC.                              |
|                                 | 1000% of current rating                                                                                                                        | >0.5msec                                                     | SART SPEC.                              |
| Voltage Drop                    | 100% of current rating                                                                                                                         | Deviation between the mean value: <15%                       | IEC-60127-4                             |
| Temperature Rise                | 100% of current rating                                                                                                                         | $\Delta T < 95^{\circ}\text{C}$                              | IEC-60127-4                             |
| Interrupting Ability            | 200A 35V DC<br>400A 26V DC                                                                                                                     | without permanent arcing, ignition and bursting of fuse link | UL248-14<br>IEC60127-4                  |
| Solderability                   | $240^{\circ}\text{C} \pm 5^{\circ}\text{C}$ , 3sec $\pm 0.5\text{sec}$                                                                         | 95% coverage Min.                                            | IEC60127-4<br>MIL-STD-202<br>Method 208 |
| Resistance to Soldering         | $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$ , 10sec $\pm 0.5\text{sec}$                                                                        | $ \Delta R  < 10\%$<br>Legible appearance                    | MIL-STD-202<br>Method 210               |
| Bending Test                    | Distance between holding points: 90mm<br>Bending: 2mm, time: 10sec                                                                             | $ \Delta R  < 10\%$<br>No mechanical damages                 | IEC60127-4                              |
| Long Operating life             | T= $25^{\circ}\text{C}$ , 80%In for 1000 hours                                                                                                 | $ \Delta U  < 20\%$                                          | SART SPEC.                              |
| High Temperature Operating Life | T= $70^{\circ}\text{C} \pm 2^{\circ}\text{C}$ , 60%In, 96hours                                                                                 | $ \Delta R  < 10\%$ ; No fusing                              | MIL-STD-202<br>Method 108               |
| Humidity (Steady State)         | T= $85^{\circ}\text{C} \pm 2^{\circ}\text{C}$ , 85%RH, 1000hours                                                                               | $ \Delta R  < 10\%$                                          | MIL-STD-202<br>Method 103               |
| Low Temperature Storage         | T= $-55^{\circ}\text{C} \pm 3^{\circ}\text{C}$ , 96hours                                                                                       | $ \Delta R  < 10\%$                                          | IEC60068-2-1                            |
| High Temperature Storage        | T= $155^{\circ}\text{C} \pm 2^{\circ}\text{C}$ , 96hours                                                                                       | $ \Delta R  < 10\%$                                          | IEC60068-2-2                            |
| Salt Spray                      | 5% salt solution, 96hours                                                                                                                      | $ \Delta R  < 10\%$<br>Legible appearance                    | MIL-STD-202<br>Method 101               |
| Thermal Shock                   | 100 cycles between $-65^{\circ}\text{C}/+125^{\circ}\text{C}$<br>60 minutes, each extreme                                                      | $ \Delta R  < 10\%$<br>No mechanical damages                 | MIL-STD-202<br>Method 107               |
| Mechanical shock                | Pulse acceleration:15000m <sup>2</sup> /sec,<br>0.5msec,half-sine shock<br>time: 6 msec,stock number:18 times                                  | $ \Delta R  < 10\%$                                          | MIL-STD-202<br>Method 213               |
| High frequency vibration        | Vibration direction: Vibration direction:<br>X / Y / Z three directions time: 10Hz ~<br>2000Hz, 20 cycles per direction,<br>240min / direction | $ \Delta R  < 10\%$                                          | MIL-STD-202<br>Method 204D              |

## Recommended Solder Curve

### 1. Infrared Reflow:

- Temperature: 260°C
- Time:20sec Max.
- Recommend Reflow profile



| Profile Feature                                                                                                    | Pb-Free Assembly               |
|--------------------------------------------------------------------------------------------------------------------|--------------------------------|
| Average Ramp-up Rate( $T_{Smax}$ to $T_P$ )                                                                        | 3°C/sec Max.                   |
| Preheat<br>Temperature Min. ( $T_{Smin}$ )<br>Temperature Max. ( $T_{Smax}$ )<br>Time ( $T_{Smin}$ to $T_{Smax}$ ) | 150°C<br>200°C<br>60sec~120sec |
| Peak Temperature( $T_P$ )                                                                                          | 260°C                          |
| Time within 5°C of actual Peak Temperature( $t_P$ )                                                                | 20sec                          |
| Melting tin time( $t_L$ )                                                                                          | 60sec~150sec                   |
| Ramp-down Rate                                                                                                     | 6°C/sec Max.                   |
| Time 25°C to peak Temperature                                                                                      | 8minutes Max.                  |

### 2. Wave soldering

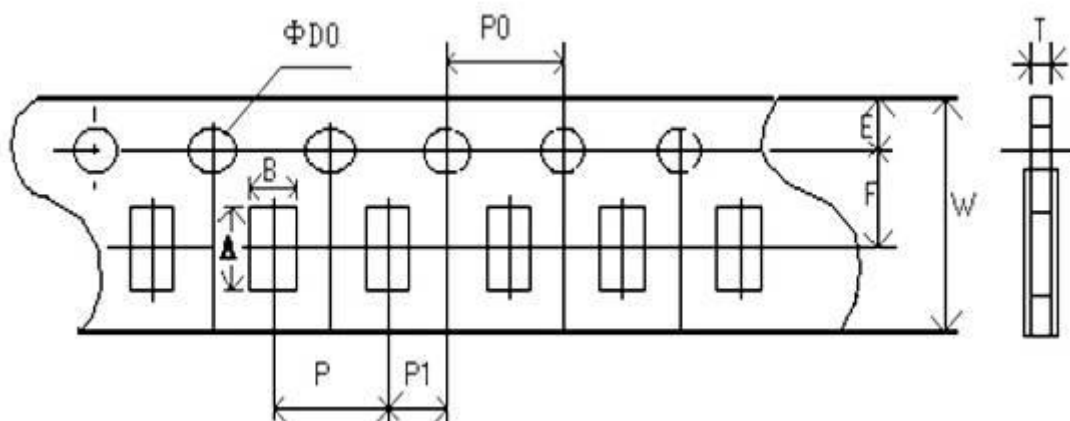
- Reservoir Temperature: 260°C
- Time in Reservoir: 10secMax.

### 3.Hand Soldering

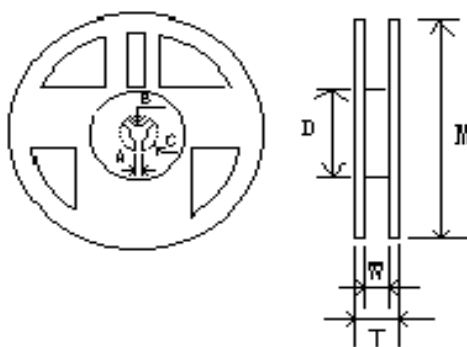
- Temperature: 350°C
- Time: 5secMax.

## Packaging

- 4000 pieces of fuses in emboss taper and reeled on a 178mm(7 inch) reel.



| Type     | A(mm)     | B(mm)     | W(mm)     | E(mm)     | F(mm)     |
|----------|-----------|-----------|-----------|-----------|-----------|
| S1206-FG | 3.50±0.05 | 2.0±0.05  | 8.00±0.10 | 1.75±0.10 | 3.50±0.05 |
| Type     | P(mm)     | P0(mm)    | P1(mm)    | D0(mm)    | T(mm)     |
| S1206-FG | 4.00±0.10 | 4.00±0.10 | 2.00±0.05 | 1.55±0.05 | 1.05±0.10 |



| Type     | M(mm)       | W(mm)     | T(mm)      | A(mm)     | B(mm)      | C(mm)      | D(mm)      |
|----------|-------------|-----------|------------|-----------|------------|------------|------------|
| S1206-FG | 178.00±2.00 | 9.50±1.00 | 12.50±1.50 | 2.00±0.50 | 13.00±0.50 | 21.00±0.50 | 58.00±2.00 |

## Storage

- The ambient temperature recommended for storage shall be between 5℃~30℃
- The relative humidity recommended for storage shall be between 25%RH~60%RH
- Sealed plastic bags with desiccant shall be used to reduce the oxidation of the termination and shall only be opened prior to use
- The products shall not be stored in areas where harmful gases containing sulfur or chlorine are present